

Digital System Integration and Programming

Introduction/Kick-Off

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IAIK – Graz University of Technology

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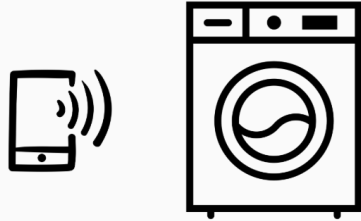
Digital system integration and programming

Digital system integration

- Digital systems: very complex
- System integration: connect multiple complex systems to achieve a certain goal

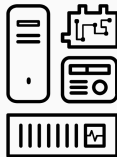
...and programming

- Hardware and Software



A **System-on-a-Chip (SoC)** is a complex system which:

- consists of several components.
- Each component itself is a complex system.
- Components include:
 - CPU
 - Memory
 - Bus architectures
 - I/O modules
 - Co-processors
 - Analog circuits
 - ...



A quick history

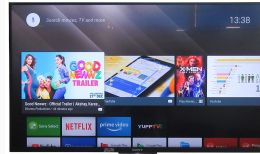
- 1970s: VLSI design
 - VLSI = Very large-scale integration
 - Combining millions of MOS transistors into an integrated circuit
- 1990s: System-on-a-chip
 - System integration: integration of a complete system, that until recently consisted of multiple ICs, onto a single IC (a SoC)
- Today: SoC is the state-of-the-art principle for designing chips.



Smartphones



Tablets



Smart TVs



Cars

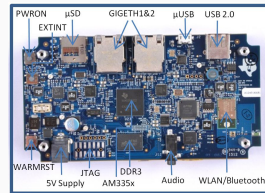
- Used in iPhone XS, XS Max, XR
- 7nm CMOS, 6.9 billion transistors
- Components:
 - 64-bit ARMv8.3A (6 performance CPUs, 4 energy-efficient CPUs)
 - Four-core GPU
 - *Neural Engine* with 8 cores
 - ...



- Used in smartphones by ZTE, Sony, OnePlus, LG, ...
- 7nm CMOS
- Components:
 - Several ARM Cortex-A77 and Cortex-A55-based CPUs
 - Dedicated processor for ISP for photos and videos
 - Wi-Fi
 - SPU: dedicated subsystem for boot-loader, key management unit, crypto accelerators, ...



- SoC for industrial applications
- Used in thermostats, firewalls, Lego Mindstorms
- 1 GHz ARM CPU
- On-chip quad-core PRU (Programmable Realtime Unit)



A **typical SoC** consists of:

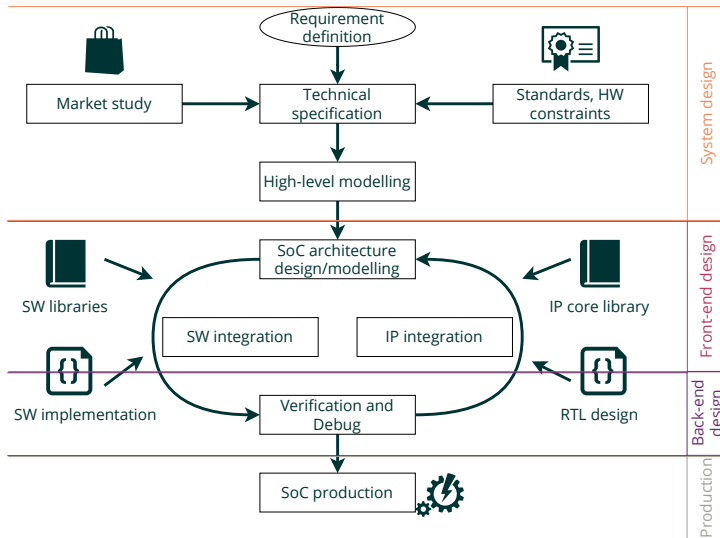
- Processor(s): mostly ARM cores
- GPU: depending on the field of application, ranging from simple cores for small LCDs to 4k screens
- Co-processors: for security, real-time signal processing, ...
- I/O interfaces: Ethernet, SPI, USB, ADC, ...
- A bus connecting all components: AMBA, AXI, CoreConnect, ...

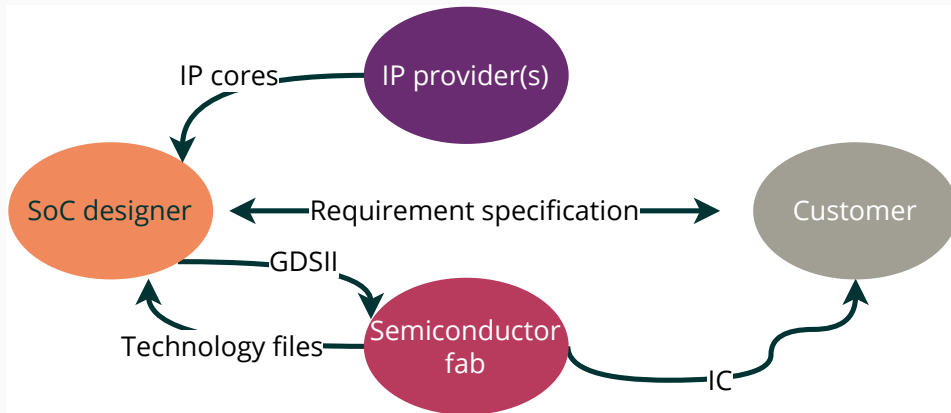
Advantages

- Low silicon area
- Power efficiency (no need for complex component **wiring**)
- Low manufacturing costs
- Smaller power supply unit

Disadvantage: resulting system is very complex

- High design and development costs





- GDSII: data format to describe ICs
- Technology file: information about manufacturing (metals, IC layers, ...)

About this course



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- General information: <https://www.iaik.tugraz.at/course/digital-system-integration-and-programming-705007-wintersemester-2021->
- Questions and concerns via Discord <https://discord.gg/9KKGfndsD5>
- Questions and concerns by E-Mail <mailto:sip-team@iaik.tugraz.at>

- We focus on the front-end design
- We use an FPGA in order to build a prototype of our SoC
- Our Platform: Zybo Zynq Boards
 - 650Mhz dual-core Cortex-A9 processor
 - HDMI, VGA, USB, SPI, Ethernet, Audio, ...

- Build a working prototype
- Project management and self-organization
- Presentation of: ideas, results, technology in English
- Preparation for project/thesis



Digital System Integration and Programming addresses **advanced-level students**. You need:

- Advanced knowledge about hardware including HDL (Verilog/VHDL) (Computer Organization and Networks is not enough!)
- Very good C/C++ skills
- Knowledge about Linux
 - Buildroot/Yocto, kernel modules, drivers, device trees, GPIO
- Knowledge about FPGAs and how to program them
- Knowledge about bus protocols, CPUs and networks
- Very good time-management skills
- Good presentation skills



We offer:

- Project driven work
 - Group oriented
 - Project centric
- Hands-on project with real hardware
- Upgrading of soft skills
 - Presentations
 - Speaking English
 - Group communication

We expect:

- Investment of time
 - SIP: 3 VU (5 ECTS)
 - $5 \times 25 = 125$ hours work = 28 days of 8 hours
- Active communication within your group
- Active participation, presence during lectures

Your grade consists of:

- Project 1: 20%
 - Individual work, independent submissions
- Project 2: 40%
 - Team work in groups of 2 or 3 students
- Seminar presentation: 40%
 - Selection from course catalog
 - Slides are reviewed by us
 - Submission until Monday evening

- Team Size for Project 1: 1
- Team Size for Project 2: 3
- Team Size for Seminar Presentation: 1

1. Find a group
2. Register your group: `mailto:sip-team@iaik.tugraz.at`
3. Wait for the confirmation mail to get your group number
4. Decide when to pick up the HW (IF01052, Mo-Fr 10:00-16:00)
5. Choose a seminar topic
6. Register for a seminar topic: `https://bit.ly/2Ys9Cvi`

Deadline: 12.10., 23:59

Project meetings

- Regular weekly meetings: Wednesday 10:00 - 12:00, online
 - Discord: <https://discord.gg/9KKGfndsD5>
 - Register in #getting-started to see channel
 - Questions: #sip
 - Finding team mates: #sip-groupsearch
 - Lecture: #sip-lecture
- Content
 - Student talks
 - Questions, problems and challenges about the current project

Date	Topic
06.10.2021	Kick-off / Introduction to Seminar Topics / SoC Design Flow Tutorial
13.10.2021	Embedded Linux Tutorial / Introduction Project 1
20.10.2021	Debugging Tutorial / Seminar talks
27.10.2021	Seminar talks
03.11.2021	Seminar talks
10.11.2021	Introduction Project 2 / Seminar talks
17.11.2021	Seminar talks
24.11.2021	Seminar talks
01.12.2021	Seminar talks
15.12.2021	Seminar talks
12.01.2021	Seminar talks
19.01.2021	Seminar talks
26.01.2021	Seminar talks

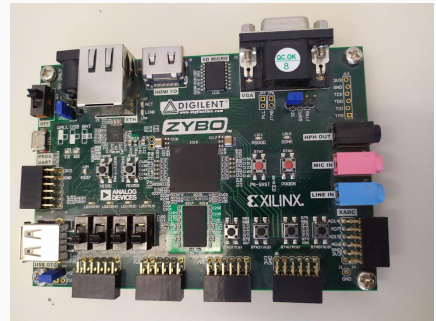
- 12.10., 23:59: Deadline Group Registration
- 09.11., 23:59: Deadline Project 1
- 10.11. - 17.11.: Interviews Project 1
- 09.12., 23:59: Deadline Project 2a
- ~~18.01.~~ 25.1., 23:59: Deadline Project 2b
- ~~19.01. - 26.01.~~ 26.1.-28.1.: Interviews Project 2a+2b

Outlook: Projects

- Get to know the board and run through all steps
- Design hardware, build a driver, write an application
- Access the LEDs from a bare-metal application and from within Linux
- No team work; everybody should do all steps (share your board within group)
- Aim: Everybody should have the same basic knowledge.



- Use knowledge from Project 1 to build larger system
- Receive encrypted image via Ethernet, decrypt it in hardware and display it via HDMI
- Team work
- Aim: Get some deeper understanding of the topic



Looking for a master project/thesis?

<https://www.iaik.tugraz.at/teaching/master-thesis/>